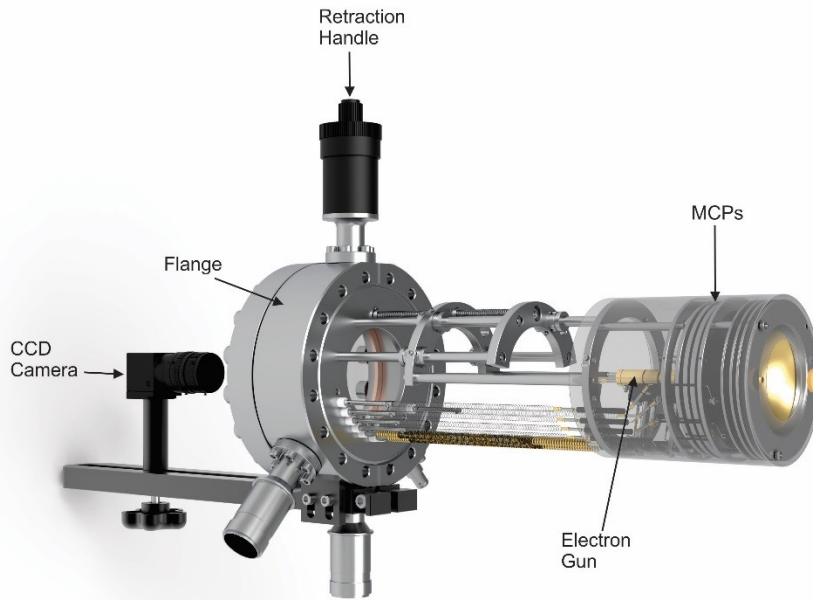


LEED 600 MCP Configuration Guide and Specifications



LEED configuration

Base configuration		
Model	Order Code	
BDL600IR-MCP1-3GR		Back-Display LEED optics, with 3 Grid-high resolution (0.2%) retarding field analyzer based on gold plated tungsten hemispherical grids with 75 deg. capture angle, integral miniature electron gun, lenses made of gold plated copper alloy, optical quality flat glass display, one 80 mm Long Life(TM) microchannel plate(MCP) and Mu-metal shield mounted on the double sided CF 6" (CF100) flange with vacuum insert diameter 94 mm . Viewport and mounting kit included. Wide beam current range: from pA to uA. Working Distance: 15 mm. Flange to sample distance: to be specified.
LMX		Integral linear retraction based on 4 linear ball bearings up to 100 mm
LPS075-D		Digital power supply (0-750 V) with USB interface and PC control software for Windows 10. True primary beam current and total emission measurements. Automatic start-up and shut down, 10 memory settings including standby and outgassing mode with timer, constant beam current mode controlled by filament current or Wehnelt voltage. All cables included.
MCPS1		Electronics for one microchannel plate with digital displays of voltages and MCP load current measurements and protection.
Options		
LaB ₆		LaB ₆ single crystal filament instead of a tungsten wire filament
MCP2		Two 80 mm LongLife™ microchannel plates (MCP) in chevron configuration instead of one MCP
MCPS2		Electronics for two microchannel plates with digital displays of voltages and MCP load current measurements and protection.
Electronics Upgrade		
LPS300-D-		Upgrade from LPS075-D to LPS300-D

UP		
LOA10-AES		Model LOA10-AES, Digital AES controller with lock-in amplifier, AES high voltage ramp board 0-2.0 kV with precision sinewave oscillator (0.5-20 Vpk-pk) and AES software. Serial RS232 or USB communication to PC. High Auger signal sensitivity based on integrated band-pass filter and pre-amplifier (0.05% of monolayer for Ag peak 351-356 eV). All cables included.

LEED and AES configuration

Base configuration		
Model	Order Code	
BDL600IR-MCP1-4GR		Back-Display LEED optics, with 4 Grid-high resolution (0.2%) retarding field analyzer based on gold plated tungsten hemispherical grids with 75 deg. capture angle, integral miniature electron gun, lenses made of gold plated copper alloy, optical quality flat glass display, one 80 mm Long Life(TM) microchannel plate(MCP) and Mu-metal shield mounted on the double sided CF 6" (CF100) flange with vacuum insert diameter 94 mm . Viewport and mounting kit included. Wide beam current range: from pA to uA. Working Distance: 15 mm. Flange to sample distance: to be specified.
LMX		Integral linear retraction based on 4 linear ball bearings up to 100 mm
LPS300-D		Digital LEED-Auger power supply (0-3.2 kV) with USB interface and PC control software for Windows 7. True primary beam current and total emission measurements. Automatic start-up and shut down, 10 memory settings including outgassing with timer, automatic switch from LEED to AES, constant beam current mode. All cables included.
MCPS1		Electronics for one microchannel plate with digital displays of voltages and MCP load current measurements and protection.
Options		
LaB ₆		LaB ₆ single crystal filament instead of a tungsten wire filament
LOA10-AES		Model LOA10-AES, Digital AES controller with lock-in amplifier, AES high voltage ramp board 0-2.0 kV with precision sinewave oscillator (0.5-20 Vpk-pk) and AES software. Serial RS232 or USB communication to PC. High Auger signal sensitivity based on integrated band-pass filter and pre-amplifier (0.05% of monolayer for Ag peak 351-356 eV). All cables included.
MCP2		Two 80 mm LongLife™ microchannel plates (MCP) in chevron configuration instead of one MCP
MCPS2		Electronics for two microchannel plates with digital displays of voltages and MCP load current measurements and protection.

LEED Software

Software Options		
Model	Order Code	
LIM12		Full version LEED pattern measurements, analysis software & hardware for Windows 10 including: -12-bit colour or black and white high-performance video CCD camera with sensitivity control - 1/3" CCD sensor size, 1.3 MP (1288x964) - sized images, 3.75 um pixel size, CS-mount lenses - Linear Full Well: 9000e-, Dynamic Range: 59 dB - PCIe express USB3.1 card (option if computer doesn't have USB3.1) - Flange mounting kit with ambient light cover and cables Software features: - Automatic LEED pattern acquisition - Automatic I-V analysis with spot tracking

		<ul style="list-style-type: none"> - Automatic I-T analysis - Automatic spot profile analysis
LIM12B		<p>Basic LEED pattern measurements and analysis software and hardware for Windows 10 including:</p> <ul style="list-style-type: none"> -12-bit colour high performance video CCD camera with sensitivity control and USB3 interface -1/3" CCD sensor size, image size: 1.3 MP (1288x964), 3.75 um pixel size, CS-mount lenses -Linear Full Well: 9000e-, Dynamic Range: 59 dB -PCIe express USB3.1 card (option if computer doesn't have USB3.1) -Automatic LEED pattern acquisition -Flange Mounting kit with ambient light cover and cables
LIM14		<p>Advanced LEED pattern measurements, analysis software & hardware for Windows 10 including:</p> <ul style="list-style-type: none"> -14-bit colour or black and white high-performance scientific grade CCD camera with sensitivity control and USB 3 interface: 2/3" CCD sensor size and 1.4-megapixel resolution (1384x1032), 6.45 um pixel size, C-mount lenses - Linear Full Well: 22,000e-, extremely low noise, Dynamic Range: 68 dB - PCIe express USB3.1card (option if computer doesn't have USB3.1) - Flange mounting kit with ambient light cover and cables. <p>Software features:</p> <ul style="list-style-type: none"> - Automatic LEED pattern acquisition - Automatic I-V analysis with spot tracking - Automatic I-T analysis - Automatic spot profile analysis

Detailed Specifications

BDL600IR-MCP optics	
Glass display	Fused silica glass coated with indium-tin oxide conductive layer and P31 phosphor (ZnS:Ag:Cu-green, 525 nm wavelength)
Angle of acceptance	92° from sample at a distance of 51 mm
Retarding Field Analyzer	Concentric assembly of hemispherical grids
Working distance from sample	15 mm
Grid material	Gold coated tungsten wire mesh (100 mesh, 81% transparency)
Energy resolution	0.2% -0.5% at low modulation voltage
Monitoring	6" standard viewport
Linear motion	Up to 100 mm retraction from sample; linear ball bearing and acme thread with all spring electrical connections
Magnetic shielding	Mu metal cylinder with front cover for maximum attenuation
Assembly	Extreme high vacuum compatibility with stainless steel, high alumina and Au-plated copper alloy materials
Mounting	6" (CF100) double sided conflat flange with sample distance 145 mm - 400 mm
Bakeability	Under vacuum, 250°C maximum

Integral miniature electron gun	
Beam energy	LEED: 0-750 eV AES: 0-3000 eV
Beam current	LEED: 2 µA at 100 eV and 0.5 mm beam size AES: up to 100 µA at 3 keV
Beam size	From 1 mm to 250 µm-adjusted by wehnelt potential, limited by exchangeable aperture down to 50 µm
Electron source	Tungsten 2% thoriated filament (standard) or single crystal LaB ₆ filament (optional)
Energy spread	0.45 eV (thoriated-tungsten filament)
Overall size	10 mm lens diameter and 80 mm length

Microchannel Plates	
Working area	75 mm
L/D ratio	40:1
Channel diameter	25 microns
Center to center spacing	32 microns
Plate thickness	1.0 mm
Bias angle	8°
Electron gain	10 ⁴ to 10 ⁵ per plate

LPS075-D and LPS300-D Electronics	
Beam Voltage	LPS075-D: negative 0-750 V LPS300-D: negative 0-3000 V
Filament current	0-3.2 A Tungsten/ 0-2.1 A LaB ₆
Wehnelt voltage	0-37 V with respect to the filament
Focus voltage	LEED: positive 70-180% of the beam voltage AES: negative 0-3000 V
Retarding (grid) voltage	Negative 50-110% of the beam voltage
Screen voltage	Positive 0-5000 V
Emission current	1-200 μA
Beam current	0.01-200 μA
Monitoring	All voltages and currents
Display	Vacuum fluorescent, displaying all voltages, currents and program functions
On-board automation	5 pre-programmed and fully programmable operating programs for outgassing, stand-by, filament forming, beam voltage scanning, constant beam current and diagnostics
Manual control	Of all voltages via rotary dials and selection switches
PC control	PC software for full control of all functions via USB
Protection	Over-voltage, over-current, and short circuit
Dimensions	3U 19" rack mount (5.25"/133 mm), depth of 17.5" (440 mm), weight 12 kg

High Voltage Ramp Generator Model LOA10-AES (Lock-In)		
Sweep Generator	Sweep Voltage	0-2000 V
	Sweep Rate	AES software controlled (16-bit DAC)
	Sweep Voltage Offset (start)	AES software controlled (16-bit DAC)
	Sweep Voltage Offset (end)	AES software controlled (16-bit DAC)
	Ramp Voltage Monitor	AES software controlled (16-bit DAC)
Internal Oscillator and Modulator	Frequency	Fixed at 1.457 kHz, trimmer adjusted ±5%
	Amplitude (peak-to-peak)	Regulated from 0.5 to 20 V (16-bit DAC)
	Distortion	Harmonic 0.1% Noise 50 μV RMS
PSD	Type	Switching multiplier
	Input Impedance	AC coupled, 100 nF into 1 MΩ
	Input	True differential
	AC Gain	10, 100, 1000, 10000 (and 1, 2, 4, 8) software selectable
	Interstage Coupling	Simple high pass typically with -3 dB per 72 Hz
	Post Detection Low Pass Filter	Equal component Sallen-Key, 2nd order with a time constant of 0.1, 0.5, 1, and 3 s
PLL	Signal Channel Equivalent Input Noise	Typically, less than 20 nV/Hz at 1 kHz
	Input Impedance	AC coupled, 10 nF into 1 MΩ
	Frequency Range	0.2-7.5 kHz with a typical phase jitter < 0.2%
ADC	Locks Onto	The fundamental or 2nd harmonic
	Chip	TI ADS7807
	Resolution	16 bits
	Accuracy	±1.5 LSB max INL
DAC	Conversion Time	25 μs
	Chip	TI DAC715
DAC	Resolution	16 bits

	Settling Time	3 μ s
	Channels	1
Computer Interface	USB	
Software	AES data acquisition and analysis software for Windows 7/10	
Dimensions	2U 19" rack mount (3.5" / 89 mm), depth of 13.5" (343 mm), weight 6 kg.	

Low Noise Input Coupler Model AUS30		
Input Impedance	10 M Ω (internal bandpass filter)	
Amplifier	FET input, 500 gain	
Dimensions	180 mm \times 105 mm \times 65 mm	
Low Noise Bandpass Filter	Central Frequency	2.95 kHz
	3 dB Band Width	200 Hz
	20 dB Band Width	7.83 kHz